



40V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
40V	10mΩ @ V _{GS} = 10V	80A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Engine management systems
- DC-DC converters
- · Body control electronics

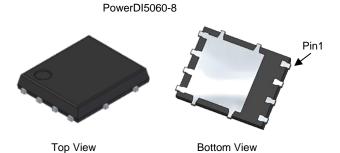
Features and Benefits

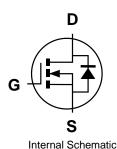
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching Ensures More Reliable and Robust End Application
- Low Q_g Minimizes Switching Loss
- Low R_{DS(ON)} Minimizes On State Loss
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMNH4011SPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

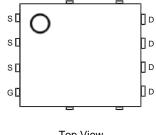
https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe, Solderable per MIL-STD-202, Method 208
- Weight: 0.097 grams (Approximate)







Top View Pin Configuration

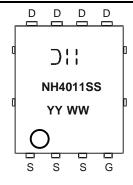
Ordering Information (Note 4)

Dort Number	Dookogo	Packing		
Part Number	Package	Qty.	Carrier	
DMNH4011SPSQ-13	PowerDI5060-8	2,500	Reel	

Note:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



Oll = Manufacturer's Marking
NH4011SS = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 24 = 2024)
WW = Week (01 to 53)

DMNH4011SPSQ Document number: DS38693 Rev. 5 - 2 1 of 7 www.diodes.com



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		V_{DSS}	40	V
Gate-Source Voltage	Gate-Source Voltage		±20	V
	T _A = +25°C T _A = +70°C	l _D	13 10.8	А
Continuous Drain Current (Note 6) V _{GS} = 10V	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$ (Note 7)	lσ	80 57	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	90	Α	
Maximum Continuous Body Diode Forward Current (Note 5)	ls	80	Α	
Pulsed Source Current (10µs Pulse, Duty Cycle = 1%)	lsм	90	Α	
Avalanche Current, L = 1mH		las	18	Α
Avalanche Energy, L = 1mH		Eas	170	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	PD	2.5	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	60	°C/W	
Total Power Dissipation (Note 6)	T _C = +25°C	P _D	150	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	1	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

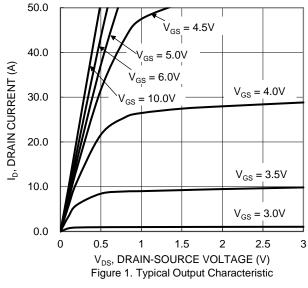
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BVDSS	40			٧	$V_{GS} = 0V, I_{D} = 250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_		1	μΑ	V _{DS} = 40V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	Vgs(th)	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	8.5	10	mΩ	$V_{GS} = 10V, I_{D} = 50A$	
Diode Forward Voltage	VsD	_	0.9	1.2	V	$V_{GS} = 0V, I_{S} = 50A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	1405	_		V _{DS} = 20V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss	_	247		pF		
Reverse Transfer Capacitance	Crss	_	108				
Gate Resistance	Rg	_	2.2		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Q_g	_	25.5				
Gate-Source Charge	Qgs	_	4.6		nC	V _{DS} = 20V, V _{GS} = 10V, I _D = 50A	
Gate-Drain Charge	Q_{gd}	_	6.9				
Turn-On Delay Time	td(on)	_	4.6			$V_{DD} = 20V$, $V_{GS} = 10V$, $I_{D} = 50A$, $R_{G} = 3.5\Omega$	
Turn-On Rise Time	t _R	_	3.7				
Turn-Off Delay Time	t _{D(OFF)}	_	16	_	ns		
Turn-Off Fall Time	tF	_	5.1	_			
Body Diode Reverse Recovery Time	trr	_	22.1	_	ns	Is = 500 di/dt = 1000/us	
Body Diode Reverse Recovery Charge	Qrr	_	13.4		nC	IF = 50A, di/dt = 100A/µs	

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

6. Thermal resistance from junction to soldering point (on the exposed drain pad).

7. Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.





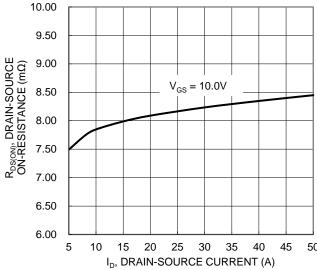


Figure 3. Typical On-Resistance vs Drain Current and Gate Voltage

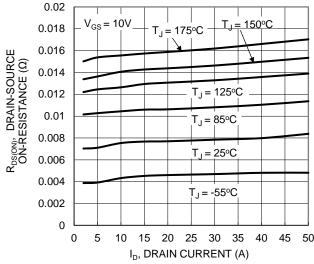
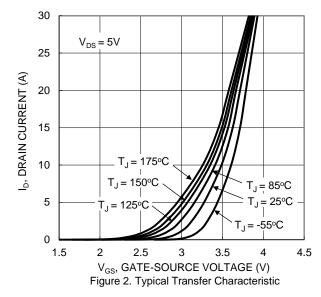
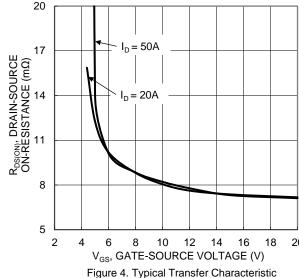


Figure 5. Typical On-Resistance vs Drain Current and Temperature





2.2 2 R_{DS(ON)}, DRAIN-SOURCE ON-RESISTANCE (NORMALIZED) 1.8 1.6 $V_{GS} = 10V, I_D = 50A$ 1.4 1.2 1 8.0 0.6 0.4 -50 -25 0 25 50 75 100 125 150 175 T_J, JUNCTION TEMPERATURE (°C)

Figure 6. On-Resistance Variation with Temperature



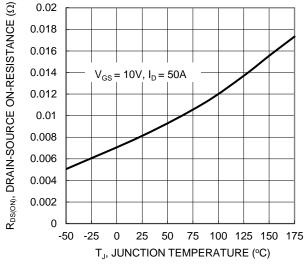
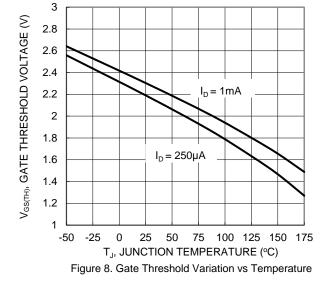
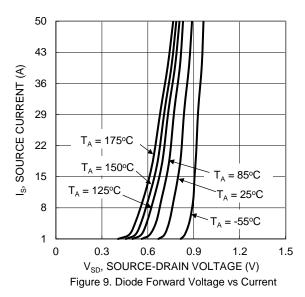
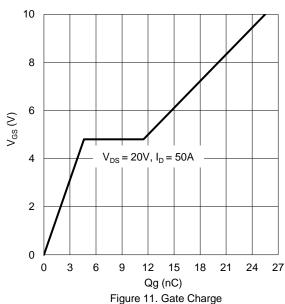
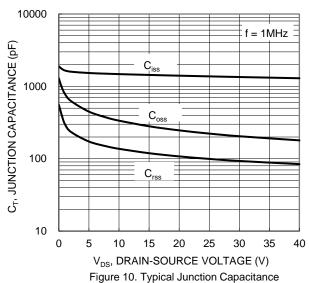


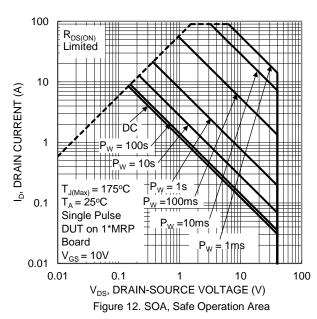
Figure 7. On-Resistance Variation with Temperature













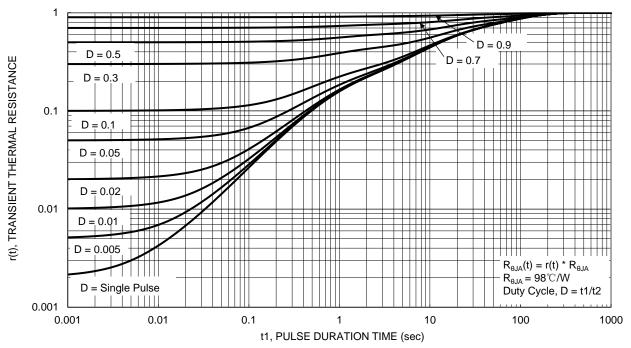


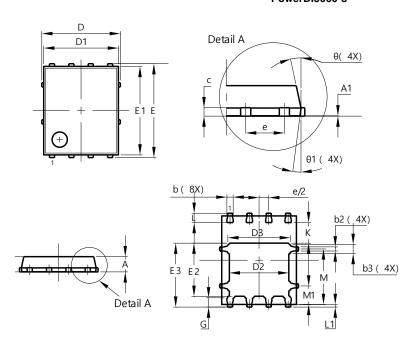
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

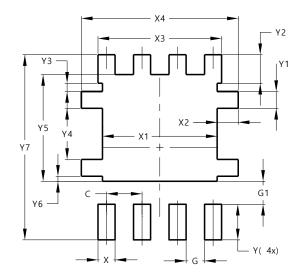


PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	-		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D	ţ	5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
Е	6.15 BSC				
E1	5.60	6.00	5.80		
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е		1.27 BSC	;		
G	0.51	0.71	0.61		
K	0.51	-	-		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610



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DMNH4011SPSQ
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